

**Product Texts**

Injection Molding, 30% Glass Reinforced, Heat Stabilized, Improved flow

ISO 1043 PA6-GF30

Processing/Physical Characteristics	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Molding shrinkage, parallel	0.2 / *	%	ISO 294-4, 2577
<sup>[C]</sup> Molding shrinkage, normal	0.7 / *	%	ISO 294-4, 2577

[C]: CAMPUS

Mechanical properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Tensile Modulus	9400 / 5500	MPa	ISO 527
<sup>[C]</sup> Stress at break	170 / 100	MPa	ISO 527
<sup>[C]</sup> Strain at break	3 / 5.8	%	ISO 527
<sup>[C]</sup> Charpy impact strength, +23°C	65 / 80	kJ/m <sup>2</sup>	ISO 179/1eU
<sup>[C]</sup> Charpy impact strength, -30°C	55 / 55	kJ/m <sup>2</sup>	ISO 179/1eU
<sup>[C]</sup> Charpy notched impact strength, +23°C	11 / 15	kJ/m <sup>2</sup>	ISO 179/1eA
<sup>[C]</sup> Charpy notched impact strength, -30°C	- / 10	kJ/m <sup>2</sup>	ISO 179/1eA
<sup>[C]</sup> Puncture - maximum force, +23°C	750 / 1050	N	ISO 6603-2
<sup>[C]</sup> Puncture - maximum force, -30°C	650 / 750	N	ISO 6603-2
<sup>[C]</sup> Puncture energy, +23°C	1.7 / 4.6	J	ISO 6603-2
<sup>[C]</sup> Puncture energy, -30°C	1.3 / 1.4	J	ISO 6603-2

[C]: CAMPUS

Thermal properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melting temperature, 10°C/min	221 / *	°C	ISO 11357-1/-3
<sup>[C]</sup> Temp. of deflection under load, 1.80 MPa	210 / *	°C	ISO 75-1/-2
<sup>[C]</sup> Temp. of deflection under load, 0.45 MPa	215 / *	°C	ISO 75-1/-2
<sup>[C]</sup> Coeff. of linear therm. expansion, parallel	20 / *	E-6/K	ISO 11359-1/-2
<sup>[C]</sup> Coeff. of linear therm. expansion, normal	100 / *	E-6/K	ISO 11359-1/-2

[C]: CAMPUS

Electrical properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Relative permittivity, 100Hz	3.63 / 4.04	-	IEC 62631-2-1
<sup>[C]</sup> Relative permittivity, 1MHz	4.43 / 9.23	-	IEC 62631-2-1
<sup>[C]</sup> Dissipation factor, 100Hz	0.02 / 0.08	E-4	IEC 62631-2-1
<sup>[C]</sup> Dissipation factor, 1MHz	0.03 / 0.13	E-4	IEC 62631-2-1
<sup>[C]</sup> Volume resistivity	>1E13 / 7.7E10	Ohm*m	IEC 62631-3-1
<sup>[C]</sup> Surface resistivity	* / 4.1E14	Ohm	IEC 62631-3-2
<sup>[C]</sup> Electric strength	31.6 / 29.1	kV/mm	IEC 60243-1
<sup>[C]</sup> Comparative tracking index	600 / -	-	IEC 60112

[C]: CAMPUS

Other properties	dry / cond	Unit	Test Standard
<sup>[C]</sup> Water absorption	7 / *	%	Sim. to ISO 62
<sup>[C]</sup> Humidity absorption	2.1 / *	%	Sim. to ISO 62
<sup>[C]</sup> Density	1360 / -	kg/m <sup>3</sup>	ISO 1183

[C]: CAMPUS

Test specimen production	Value	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Injection Molding, melt temperature	270	°C	ISO 294
Injection Molding, mold temperature	80	°C	ISO 294

[C]: CAMPUS

<b>Processing Recommendation Injection Molding</b>	<b>Value</b>	<b>Unit</b>	<b>Test Standard</b>
Pre-drying - Temperature	<b>80</b>	°C	-
Pre-drying - Time	<b>2 - 6</b>	h	-
Processing humidity	<b>≤0.12</b>	%	-
Melt temperature	<b>260 - 280</b>	°C	-
Mold temperature	<b>80 - 120</b>	°C	-

**Characteristics****Processing**

Injection Molding

**Special Characteristics**

Heat stabilized or stable to heat

**Delivery form**

Pellets

**Regional Availability**

North America, Europe, Asia Pacific, South and Central America, Near East/Africa

**Other text information****Injection molding**

## PREPROCESSING

Residual moisture content: 0.03 - 0.12%

Drying temperature dry air dryer: 80 °C

Drying time dry air dryer 2 - 6 h

## PROCESSING

Melt temperature (Tmin - Tmax): 260 - 280 °C

Mold temperature: 80 - 120 °C